

# INTERNATIONAL STANDARD

# NORME INTERNATIONALE

**Industrial communication networks – Fieldbus specifications –  
Part 4-1: Data-link layer protocol specification – Type 1 elements**

**Réseaux de communication industriels – Spécifications des bus de terrain –  
Partie 4-1: Spécification du protocole de la couche liaison de données –  
Éléments de type 1**





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## CONTENTS

FOREWORD.....	9
0 INTRODUCTION .....	11
0.1 General .....	11
0.2 Nomenclature for references within this standard .....	11
1 Scope.....	12
1.1 General .....	12
1.2 Specifications .....	12
1.3 Procedures.....	12
1.4 Applicability.....	13
1.5 Conformance.....	13
2 Normative references .....	13
3 Terms, definitions, symbols and abbreviations.....	14
3.1 Reference model terms and definitions.....	14
3.2 Service convention terms and definitions.....	16
3.3 Terms and definitions .....	16
3.4 Symbols and abbreviations.....	25
4 Overview of the DL-protocol .....	29
4.1 Three-level model of the DLL.....	29
4.2 Service provided by the DLL.....	31
4.3 Structure and definition of DL addresses.....	38
4.4 Service assumed from the PhL.....	50
4.5 Functions of the DLL .....	52
4.6 Functional classes.....	55
4.7 Local parameters, variables, counters, timers and queues.....	56
5 General structure and encoding of PhIDUs and DLPDUs, and related elements of procedure.....	70
5.1 PhIDU structure and encoding.....	70
5.2 Common DLPDU structure, encoding and elements of procedure .....	70
6 DLPDU-specific structure, encoding and elements of procedure .....	81
6.1 Establish connection (EC) DLPDU.....	83
6.2 Disconnect connection (DC) DLPDU.....	85
6.3 Reset connection (RC) DLPDU.....	88
6.4 Compel acknowledgement (CA) DLPDU .....	89
6.5 Compel data (CD) DLPDU .....	96
6.6 Exchange data (ED) DLPDU.....	103
6.7 Data (DT) DLPDU.....	111
6.8 Status response (SR) DLPDU.....	118
6.9 Compel time (CT) DLPDU .....	121
6.10 Time distribution (TD) DLPDU .....	123
6.11 Round-trip-delay query (RQ) DLPDU .....	125
6.12 Round-trip-delay reply (RR) DLPDU .....	127
6.13 Probe node DL-address (PN) DLPDU .....	129
6.14 Probe response (PR) DLPDU .....	131
6.15 Pass token (PT) DLPDU .....	133
6.16 Execute sequence (ES) DLPDU .....	141
6.17 Return token (RT) DLPDU .....	148

6.18	Request interval (RI) DLPDU .....	149
6.19	Claim LAS (CL) DLPDU .....	150
6.20	Transfer LAS (TL) DLPDU .....	152
6.21	Wake-up (WK) DLPDU .....	155
6.22	Idle (IDLE) DLPDU .....	157
6.23	Spare DLPDUs .....	158
6.24	Reserved (not to be used) DLPDUs .....	159
7	DLPDU-parameter structure and encoding .....	160
7.1	Structure and encoding of EC-PARAMETERS .....	160
7.2	Structure and encoding of DC-PARAMETERS .....	165
7.3	Structure and encoding of RC-PARAMETERS .....	166
7.4	Structure and encoding of SD-Parameters .....	168
7.5	Structure and encoding of SR-parameters .....	176
7.6	Structure and encoding of TD-parameters .....	176
7.7	Structure and encoding of RQ-parameters .....	179
7.8	Structure and encoding of RR-parameters .....	179
7.9	Structure and encoding of PN-parameters .....	180
7.10	Structure and encoding of DD-parameters .....	182
8	DL-service elements of procedure .....	182
8.1	Operation of the DL(SAP)-address, buffer and queue management services .....	183
8.2	Operation of the connection-mode services .....	186
8.3	Operation of the connectionless-mode services .....	226
8.4	Operation of the scheduling guidance services .....	237
9	DL-support subprotocol .....	246
9.1	General .....	246
9.2	Overview of LAS operation .....	247
9.3	DL-support subprotocol definition .....	247
9.4	Elements of Procedures for receiving SPDUs .....	280
10	Other DLE elements of procedure .....	282
10.1	DLE initialization .....	282
10.2	LAS behavior and operation .....	286
10.3	DL-support operation .....	293
10.4	DL-bridge elements of procedure and bridge sub-protocol .....	298
10.5	DL-management-information .....	328
10.6	Implementation profiles .....	332
11	PICS proforma .....	337
11.1	Introduction .....	338
11.2	General .....	338
11.3	Normative references .....	338
11.4	Definitions .....	338
11.5	Abbreviations .....	338
11.6	Conformance .....	339
11.7	Instructions .....	339
11.8	Identification .....	339
11.9	Implementation profile .....	340
11.10	Major low-level capabilities .....	344
11.11	Major high-level capabilities .....	357
Annex A	(informative) Exemplary FCS implementation .....	366

Annex B (informative) Type 1: Formal protocol finite state machines.....	368
B.1 Basic reception and transmission FSMs .....	368
B.2 FSMs for DLCs.....	379
B.3 FSMs for scheduling.....	385
B.4 FSMs for bridges.....	385
Annex C (informative) Type 1: DLPDU and DL-addressing short-form summaries.....	387
C.1 Fields used in short-form summaries .....	387
C.2 DLPDU short-form summary grouped by function .....	388
C.3 DLPDU short-form summary in alphabetic order of DLPDU names .....	390
C.4 DLPDU short-form summary in alphabetic order of DLPDU acronyms.....	391
C.5 DLPDU FC code-point assignment matrix – overview and detail .....	392
C.6 SD-parameters (status and data-description parameters) of CA, CD, ED and DT DLPDUs.....	395
C.7 EC parameters of EC DLPDUs .....	398
C.8 Parameters of DC and RC DLPDUs.....	400
C.9 Parameters of TD, RQ and RR DLPDUs .....	401
C.10 Parameters of PN, PT, ES and RI DLPDUs .....	404
C.11 Addressing summary extracted from figures and tables of 4.3 .....	404
Bibliography.....	409
Figure 1 – Relationships of DLSAPs, DLSAP-addresses, DLCEPs, DLCEP-addresses, DLSEP-addresses and group DL-addresses .....	19
Figure 2 – Basic structure of a DL-address .....	38
Figure 3 – Basic structure of a sublink selector.....	39
Figure 4 – DL-address alternative structures.....	39
Figure 5 – Basic structure of MAC-addresses.....	49
Figure 6 – Representation of a DL-address as a MAC-address .....	49
Figure 7 – Linear relationships of sending and receiving DLCEP sequence-number variables.....	62
Figure 8 – DL-address alternative structures.....	73
Figure 9 – SHORT DL-address field – alternative implicit structures.....	74
Figure 10 – NODE DL-address field – implicit structure .....	74
Figure 11 – State transition diagram for a DLCEP .....	187
Figure 12 – Projection of the sending and receiving DLCEP sequence-number variables of Figure 7 onto the cyclic sequence-number parameters of CA, CD, DT, ED and RC DLPDUs, with consequent determination of required actions.....	203
Figure 13 – State transitions of a DLE .....	283
Figure 14 – Bridged network topology.....	299
Figure 15 – Spanning tree representation .....	300
Figure 16 – DLSDU transit delay, DLPDU lifetime and bridge forwarding delay.....	304
Figure 17 – Forwarding and delivering a received DLPDU .....	308
Figure 18 – Forwarding a locally-originated DLPDU .....	309
Figure 19 – Republishing a DLSDU received from another link .....	310
Figure 20 – Bridge architecture.....	311
Figure 21 – Replacement for [IL] Fig 3-2 Bridge ports .....	320
Figure 22 – Replacement for [IL] Fig 3-3 Bridge architecture .....	321
Figure A.1 – Example of FCS generation .....	366

Figure A.2 – Example of FCS syndrome checking on reception.....	366
Figure C.1 – Gross structure of FC code points .....	392
Figure C.2 [Figure 2] – Basic structure of a DL-address .....	405
Figure C.3 [Figure 3] – Basic structure of a sublink selector.....	405
Figure C.4 [Figure 4] – DL-address alternative structures .....	405
Figure C.5 [Figure 5] – Basic structure of MAC-addresses .....	405
Figure C.6 [Figure 6] – Representation of a DL-address as a MAC-address .....	405
Table 1 – Link    node    selector addressing .....	41
Table 2 – Link-local node    selector addressing.....	43
Table 3 – Link-local node designators.....	45
Table 4 – Node-local selector addressing .....	46
Table 5 – Predefined flat non-local DL-addresses .....	47
Table 6 – Predefined flat link-local DL-addresses .....	48
Table 7 – Predefined node-local DL-addresses .....	48
Table 8 – Correlation of DLPDUs with functional classes .....	54
Table 9 – FCS length, polynomial and expected residual .....	76
Table 10 – Summary structure of DLPDUs.....	82
Table 11 – DLPDU restrictions based on dominant token.....	83
Table 12 – Structure of EC DLPDUs.....	83
Table 13 – Structure of DC DLPDUs .....	86
Table 14 – Structure of RC DLPDUs.....	88
Table 15 – Structure of CA DLPDUs.....	90
Table 16 – Structure of CD DLPDUs .....	96
Table 17 – Structure of ED DLPDUs .....	103
Table 18 – Structure of DT DLPDUs .....	111
Table 19 – Structure of SR DLPDUs .....	119
Table 20 – Structure of CT DLPDUs .....	121
Table 21 – Structure of TD DLPDUs .....	123
Table 22 – Structure of RQ DLPDUs.....	125
Table 23 – Structure of RR DLPDUs .....	127
Table 24 – Structure of PN DLPDUs .....	129
Table 25 – Structure of PR DLPDUs .....	132
Table 26 – Structure of PT DLPDUs.....	133
Table 27 – Structure of ES DLPDUs .....	142
Table 28 – Structure of RT DLPDUs .....	148
Table 29 – Structure of RI DLPDUs.....	149
Table 30 – Structure of CL DLPDUs.....	150
Table 31 – Structure of TL DLPDUs .....	152
Table 32 – Structure of WK DLPDUs.....	155
Table 33 – Structure of IDLE DLPDUs.....	157
Table 34 – Assumed structure of undefined (spare) DLPDUs .....	158
Table 35 – Assumed structure of RESERVED (NOT TO BE USED) DLPDUs .....	160



Table 36 – Structure of an EC DLPDU's parameters .....	161
Table 37 – EC-parameters: 1st octet.....	161
Table 38 – EC-parameters: 2nd octet.....	161
Table 39 – EC-parameters: 3rd and 4th octets .....	162
Table 40 – EC-parameters: 5th and 6th octets .....	162
Table 41 – EC-parameters: 7th octet .....	163
Table 42 – EC-parameters: 8th octet .....	163
Table 43 – EC-parameters: 9th and 10th octets .....	164
Table 44 – EC-parameters: 11th octet.....	164
Table 45 – EC-parameters: 12th octet.....	165
Table 46 – EC-parameters: 13th and 14th octets .....	165
Table 47 – DC-parameters and RC-parameters: 1st octet .....	165
Table 48 – DC-parameters and RC-parameters: 2nd octet .....	166
Table 49 – Disconnect reasons .....	167
Table 50 – Reset reasons .....	168
Table 51 – RC-parameters: 3rd octet .....	168
Table 52 – RC-parameters: 4th octet .....	168
Table 53 – Structure of connectionless-mode CA, CD, DT and ED DLPDUs.....	169
Table 54 – Short format SD-parameters for connectionless transaction initiators .....	170
Table 55 – Short format SD-parameters for connectionless responders .....	170
Table 56 – Reply status for unitdata-acknowledgment and exchange-unitdata-reply DT DLPDUs.....	171
Table 57 – Structure of connection-oriented CA, CD, DT and ED DLPDUs.....	173
Table 58 – Short format SD-parameters for DLCEP state.....	174
Table 59 – Long format SD-parameters for DLCEP state: 1st octet .....	174
Table 60 – Long format SD-parameters for DLCEP state: 2nd octet.....	174
Table 61 – Long format SD-parameters for DLCEP state: 3rd octet.....	175
Table 62 – Reply status for SR DLPDUs .....	176
Table 63 – Short format SR-parameters.....	176
Table 64 – Structure of TD-parameters .....	177
Table 65 – Structure and encoding of the DL-time-quality measures .....	177
Table 66 – Approximate numeric significance of the bits of seven-octet DL-time .....	178
Table 67 – Approximate numeric significance of the bits of three-octet short time .....	179
Table 68 – Structure of RQ-parameters .....	179
Table 69 – Structure of RR-parameters.....	179
Table 70 – Structure and encoding of the RR-time-quality measures .....	180
Table 71 – Structure of PN-parameters .....	181
Table 72 – PN-parameters: 1st octet.....	181
Table 73 – PN-parameters: 2nd octet.....	181
Table 74 – PN-parameters: 3rd and 4th octets .....	181
Table 75 – PN-parameters: 5th octet .....	182
Table 76 – PN-parameters: 6th octet .....	182
Table 77 – Structure of DD-parameters.....	182

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 IEC 61158-4-1:2014



Table 78 – Components of returned DL-time.....	238
Table 79 – Time synchronization computation.....	240
Table 80 – SPDU 1st octet: SPDU class, and protocol version or subclass .....	248
Table 81 – Probe-response SPDU .....	249
Table 82 – DL-protocol versions supported .....	249
Table 83 – PR-SPDU: 3rd and 4th octets .....	249
Table 84 – Node-activation SPDU .....	251
Table 85 – Node-activation SPDU: 4th octet .....	251
Table 86 – LAS-data-base-status SPDU .....	252
Table 87 – LAS-data-base-status SPDU: 2nd octet .....	252
Table 88 – Live-list- change SPDU .....	252
Table 89 – DLE-status structure.....	253
Table 90 – Live-list-detail SPDU .....	254
Table 91 – DL-conformance-reply SPDU.....	255
Table 92 – DL-protocol versions supported .....	255
Table 93 – DL-conformance encoding (portion 1).....	255
Table 94 – DL-conformance encoding (portion 2).....	256
Table 95 – DL-conformance encoding (portion 3).....	256
Table 96 – DL-conformance encoding (portion 4).....	256
Table 97 – Link-basic-parameters-reply SPDU .....	257
Table 98 – Link-master-parameters-reply SPDU .....	258
Table 99 – Token-hold-time-request SPDU .....	259
Table 100 – Token-hold-time-array SPDU .....	259
Table 101 – Sequence element header encoding .....	261
Table 102 – SHORT DL-address and duration sequence element .....	261
Table 103 – LONG DL-address and duration sequence element .....	262
Table 104 – Wakeup request sequence element .....	263
Table 105 – Schedule-request SPDU .....	264
Table 106 – Sequence type, schedule type and priority encoding .....	264
Table 107 – Scheduling-completed SPDU.....	266
Table 108 – Status and reason codes .....	266
Table 109 – Cancel-schedule SPDU .....	266
Table 110 – Schedule-cancelled SPDU.....	267
Table 111 – Link-schedule .....	268
Table 112 – Schedule-summary SPDU .....	268
Table 113 – Subschedule-SPDU reference .....	269
Table 114 – Subschedule SPDU .....	270
Table 115 – Sequence Sub-SPDU .....	271
Table 116 – Element-description.....	271
Table 117 – Schedule-summary-request SPDU.....	272
Table 118 – Subschedule-request SPDU .....	273
Table 119 – Parameter-list element-header encoding .....	273
Table 120 – Begin/end-of-list element.....	274

Table 121 – Continuation-of-list element.....	274
Table 122 – SHORT DL-address list element.....	274
Table 123 – LONG DL-address element.....	275
Table 124 – DLSAP-address-characteristics element.....	275
Table 125 – DLCEP-characteristics element.....	276
Table 126 – Address-query SPDU.....	276
Table 127 – Address-report SPDU.....	277
Table 128 – Address-list-query SPDU.....	278
Table 129 – DL-address selection criteria.....	279
Table 130 – Address-list-reply SPDU.....	280
Table 131 – Topology change notification BPDU format.....	328
Table 132 – Configuration BPDU format.....	328
Table 133 – Maximum permitted phase-tracking error in a DLE’s sense of DL-time at the minimum requireable Time Distribution period.....	336
Table C.1 – Generic assignment of FC code points.....	393
Table C.2 – Individual assignment of FC code points.....	394
Table C.3 – Reply status for SR DLPDUs.....	397
Table C.4 – Reply status for unitdata-acknowledgment and exchange-unitdata-reply DT DLPDUs.....	398
Table C.5 – Approximate numeric significance of the bits of seven-octet DL-time.....	403
Table C.6 – Approximate numeric significance of the bits of N(NT), A...A, and three-octet C(NT).....	403
Table C.7 [Table 1] – Link    node    selector addressing.....	406
Table C.8 [Table 2] – Link-local node    selector addressing.....	406
Table C.9 [Table 5] – Predefined flat non-local DL-addresses.....	407
Table C.10 [Table 6] – Predefined flat link-local DL-addresses.....	407
Table C.11 [Table 3] – Link-local node designators.....	408
Table C.12 [Table 4] – Node-local selector addressing.....	408
Table C.13 [Table 7] – Predefined node-local DL-addresses.....	408

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Type 1 elements**

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- Improved terms

The text of this standard is based on the following documents:

FDIS	Report on voting
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Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

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- amended.

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[IEC 61158-4-1:2014](https://standards.iteh.ai/catalog/standards/sist/dc039f09-2cf9-437c-ac54-7775e1f7ab26/iec-61158-4-1-2014)

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## 0 INTRODUCTION

### 0.1 General

This part of IEC 61158 is one of a series produced to facilitate the interconnection of automation system components. It is related to other standards in the set as defined by the “three-layer” fieldbus reference model described in IEC 61158-1.

The data-link protocol provides the data-link service by making use of the services available from the physical layer. The primary aim of this standard is to provide a set of rules for communication expressed in terms of the procedures to be carried out by peer data-link entities (DLEs) at the time of communication. These rules for communication are intended to provide a sound basis for development in order to serve a variety of purposes:

- a) as a guide for implementors and designers;
- b) for use in the testing and procurement of equipment;
- c) as part of an agreement for the admittance of systems into the open systems environment;
- d) as a refinement to the understanding of time-critical communications within OSI.

This standard is concerned, in particular, with the communication and interworking of sensors, effectors and other automation devices. By using this standard together with other standards positioned within the OSI or fieldbus reference models, otherwise incompatible systems may work together in any combination.

IEE STANDARD PREVIEW

### 0.2 Nomenclature for references within this standard

Clauses, including annexes, can be referenced in their entirety, including any subordinate subclauses, as “Clause N” or “Annex N”, where N is the number of the clause or letter of the annex.

<https://standards.iteh.ai/catalog/standards/sist/dc039f09-2cf9-437c-ac54-7775e1f7ab26/iec-61158-4-1-2014>

Subclauses can be referenced in their entirety, including any subordinate subclauses, as “N.M” or “N.M.P” and so forth, depending on the level of the subclause, where N is the number of the subclause or letter of the annex, and M, P and so forth represent the successive levels of subclause up to and including the subclause of interest.

When a clause or subclause contains one or more subordinate subclauses, the text between the clause or subclause heading and its first subordinate subclause can be referenced in its entirety as “N.0” or “N.M.0” or “N.M.P.0” and so forth, where N, M and P are as above. Stated differently, a reference ending with “.0” designates the text and figures between a clause or subclause header and its first subordinate subclause.

NOTE This nomenclature provides a means of referencing text in hanging clauses. Such clauses existed in earlier editions of IEC 61784-3, Type 1 clauses. Those hanging clauses are maintained in this edition to minimize the disruption to existing national and multi-national standards and consortia documents which reference that prior subclause numbering.

# INDUSTRIAL COMMUNICATION NETWORKS – FIELDBUS SPECIFICATIONS –

## Part 4-1: Data-link layer protocol specification – Type 1 elements

### 1 Scope

#### 1.1 General

The data-link layer provides basic time-critical messaging communications between devices in an automation environment.

This protocol provides the data-link service by making use of the services available from the physical layer. The relationship between the International Standards for fieldbus data-link service, fieldbus data-link protocol, fieldbus physical service and systems management is described in IEC 61158-1.

This protocol provides communication opportunities to all participating data-link entities

- a) in a cyclic asynchronous manner, sequentially to each of those data-link entities, and
- b) in a synchronous manner, either cyclically or acyclically, according to a pre-established schedule.

The specified protocol also provides means of changing the set of participating data-link entities and of modifying the set of scheduled communications opportunities. When the set of scheduled communications opportunities is null, the distribution of communication opportunities to the participating data-link entities is completely asynchronous.

Thus this protocol can be characterized as one which provides access asynchronously but with a synchronous overlay.

#### 1.2 Specifications

This standard specifies

- a) procedures for the timely transfer of data and control information from one data-link user entity to a peer user entity, and among the data-link entities forming the distributed data-link service provider;
- b) the structure of the fieldbus DLPDUs used for the transfer of data and control information by the protocol of this standard, and their representation as physical interface data units.

NOTE In IEC 61158-4-1, gray boxes have been used in the tables to indicate that the specified field is not a conceptual part of the specific DLPDU.

#### 1.3 Procedures

The procedures are defined in terms of

- a) the interactions between peer DL-entities (DLEs) through the exchange of fieldbus DLPDUs;
- b) the interactions between a DL-service (DLS) provider and a DLS-user in the same system through the exchange of DLS primitives;
- c) the interactions between a DLS-provider and a Ph-service provider in the same system through the exchange of Ph-service primitives.

## 1.4 Applicability

These procedures are applicable to instances of communication between systems which support time-critical communications services within the data-link layer of the OSI or fieldbus reference models and which require the ability to interconnect in an open systems interconnection environment.

Profiles provide a simple multi-attribute means of summarizing an implementation's capabilities, and thus its applicability to various time-critical communications needs.

## 1.5 Conformance

This standard also specifies conformance requirements for systems implementing these procedures. This standard does not contain tests to demonstrate compliance with such requirements.

## 2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE All parts of the IEC 61158 series as well as IEC 61784-1 and IEC 61784-2 are maintained simultaneously. Cross-references to these documents within the text therefore refer to the editions as dated in this list of normative references.

IEC 61158-1:2014, *Industrial communication networks – Fieldbus specifications – Part 1: Overview and guidance for the IEC 61158 and IEC 61784 series*

IEC 61158-2:2014, *Industrial communication networks – Fieldbus specifications – Part 2: Physical layer specification and service definition*

IEC 61158-3-1:2014, *Industrial communication networks – Fieldbus specifications – Part 3-1: Data link service definition – Type 1 elements*

ISO/IEC 7498-1, *Information technology – Open Systems Interconnection – Basic Reference Model: The Basic Model*

ISO/IEC 7498-3, *Information technology – Open Systems Interconnection – Basic Reference Model: Naming and addressing*

ISO/IEC 8886, *Information technology – Open Systems Interconnection – Data link service definition*

ISO/IEC 10038:1993, *Information technology – Telecommunications and information exchange between systems – Local area networks – Media access control (MAC) bridges*

NOTE This edition has been withdrawn and replaced by ISO/IEC 15802-3:1998. However, the detailed references in this standard are to the 1993 edition.

ISO/IEC 10731, *Information technology – Open Systems Interconnection – Basic Reference Model – Conventions for the definition of OSI services*